Electronic Lock-In Amplifier for Low Cost Radiation Thermometry

By Sam Maxwell

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Temperature Measurement

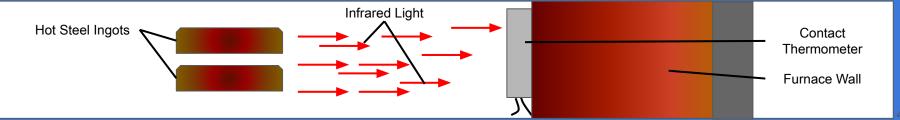
- Accurate and reliable temperature
 measurement is a common problem across
 a range of Industrial Sectors [1].
- Examples are the Pharmaceutical, Chemical and Steel Industries.
- The most commonly used type of thermometer is the contact thermometer [2].



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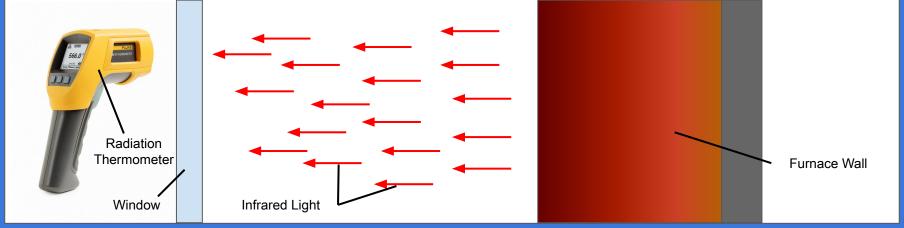
Contact Thermometers

- Unfortunately, contact thermometers do not operate effectively in high temperature environments:
 - Sources of radiation in the environment heat up the contact thermometer. This makes the reading an average of the contacted surface and environment temperature [2].
 - Maintenance and repair is also more difficult as the Thermometer has to be installed inside the measured environment.



Radiation Thermometers

- Radiation Thermometers measure the Black Body Radiation (mostly Infrared) emitted by objects at a temperature above 0K [2].
- This allows a small section of surface temperature to be measured from a distance, with lenses focusing the light onto the detector.



Radiation Thermometers

- Unfortunately, several factors externally influence a Radiation
 Thermometers output signal [2]:
 - Reflections (Reflective Materials)
 - Emissivity
 - Atmospheric Scattering
 - Atmospheric Absorption

This leads to a small output signal from the detector!

Detecting these Signals

 Sensitive and Low-Noise circuitry is required to accurately measure these signals and produce a reliable temperature reading.

Lock-In Amplifiers are a method of measuring these signals, they can measure down to *pA* [3].





- Mechanical components: require maintenance, calibration, fluctuate.
 - Cost upwards of £1000 for unit alone [4]. Mechanical chopper forms additional cost.

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Project Aims and Specifications

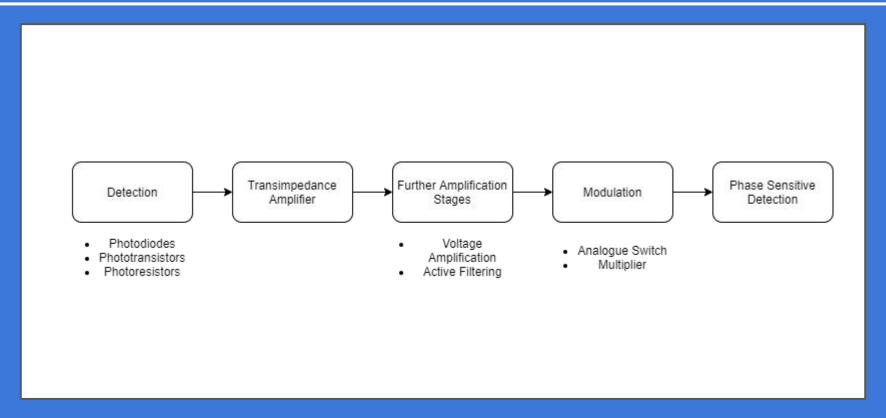
Develop a Low-Cost, Fully Electronic Lock-In Amplifier.

Key Points:

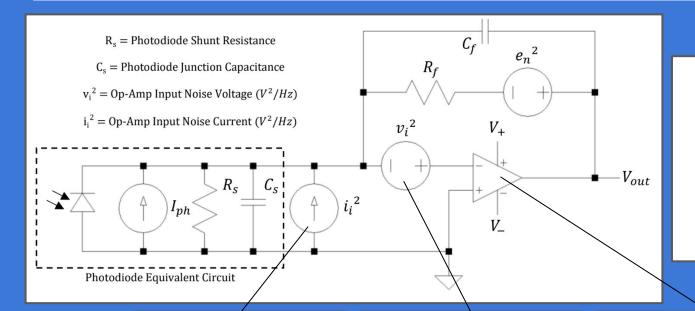
- Fully Electronic ⇒ No mechanical components.
- Low Cost ⇒ Approximately £100 target.
- Small Form Factor, capable of being adapted to Hand Held Units.
- Detectable temperature range of 400 to 1000 degrees celsius. I.e measurement down to *pA*.
- Improve performance over previous design by Tarick Osman [5].

What is a Lock-In Amplifier?

Key components of a Lock-In Amplifier System [6]



Transimpedance Amplifiers [3]



Gain and Corner Frequency

$$\frac{V_{out}}{I_{in}} = -\frac{R_f}{j\omega C_f R_f + 1} \quad \Omega$$

$$\lim_{\omega \to 0} \frac{V_{out}}{I_{in}} = -R_f \qquad \Omega$$

$$f_c = \frac{1}{2\pi C_f R_f} \quad Hz$$

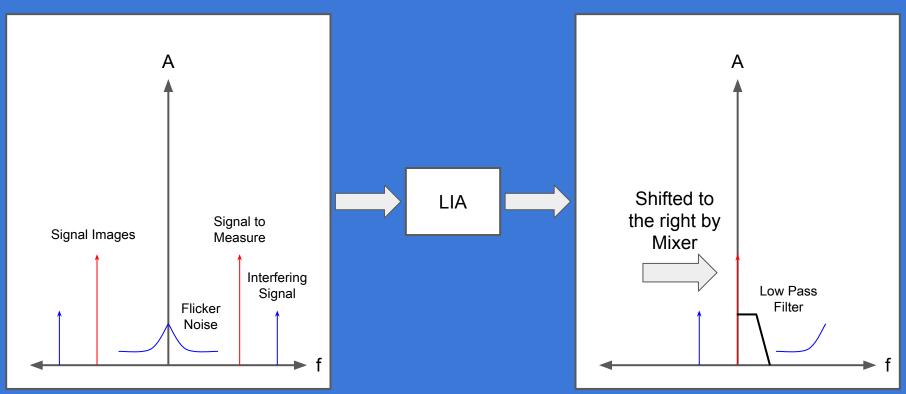
Johnson Current Noise Spectral Density

$$i_n = \sqrt{\frac{4kT}{R}} \quad \frac{A}{\sqrt{Hz}}$$

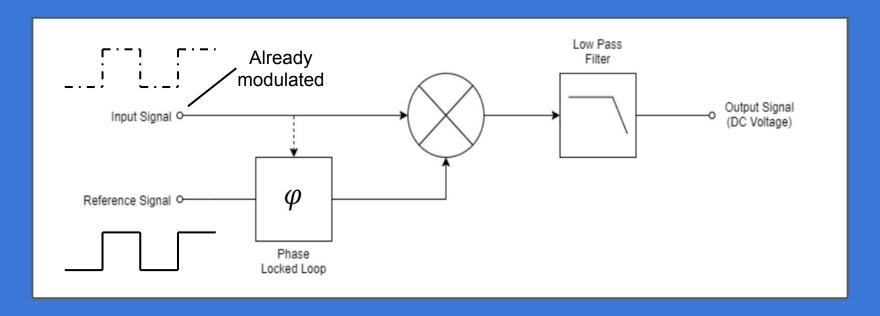
$$e_n = \sqrt{4kTR} \quad \frac{V}{\sqrt{Hz}}$$

$$i_n = \sqrt{2qI_{dc}} \quad \frac{A}{\sqrt{Hz}}$$

Lock-In Amplifiers [6]



Lock-In Amplifiers [6]



Output DC Signal
$$\approx \frac{664V_SV_R}{75\pi^2}$$

Producing a Design

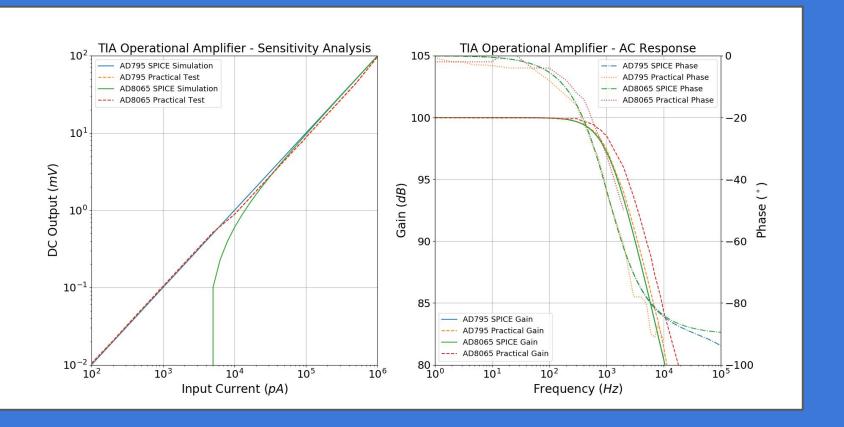
TIA Operational Amplifier Selection

Key Requirements:

- Low Input Noise Current and Voltage
- Low Flicker Noise
- Low Input Bias Current
- Standard IC Package
- Gain of 100,000 (To facilitate pA to nA signal detection)

Based upon these requirements a list of candidate Operational Amplifiers was produced.

TIA Operational Amplifier Selection [7]



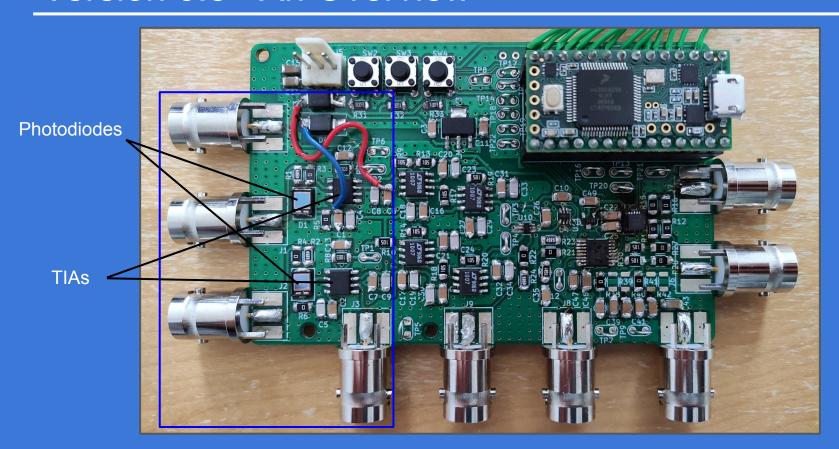
TIA Operational Amplifier Selection

Based upon these results:

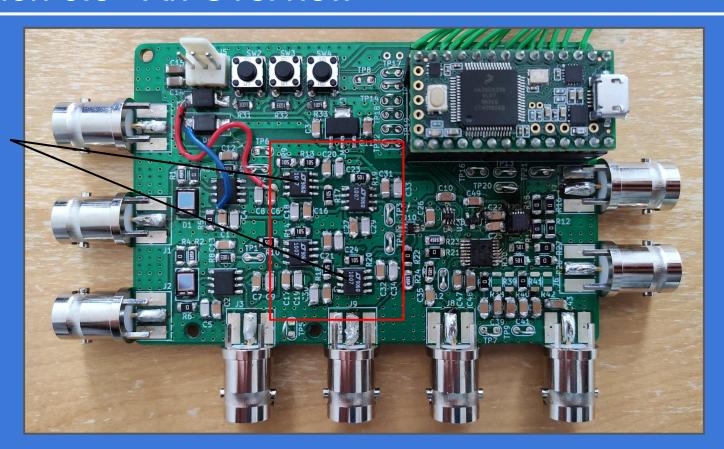
- AD795 and AD8065 selected for further testing. AD8065 primary candidate due to its lower cost of £3.20 [8] [9].
- Selected because of their optimal frequency, linearity and noise response across operating frequency spectrum.
- Standard SOIC 8 Pin package provides component flexibility for the future.

LIA IC Selection

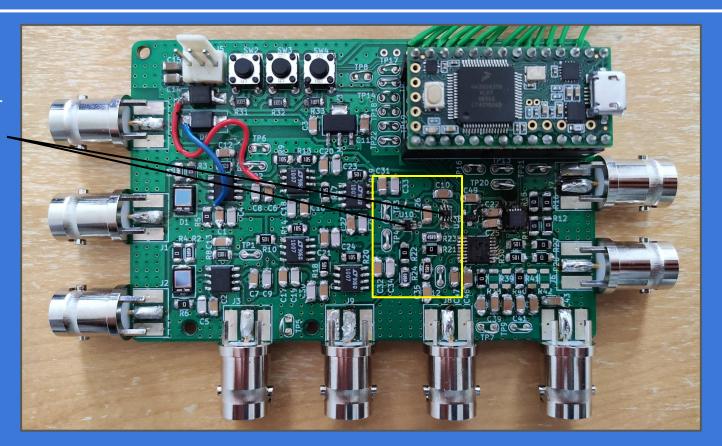
- Tarick Osman's design uses the AD630 [5] ⇒ DISCONTINUED!
- Replacement IC provided, the ADA2200 [10]. This performs a digital implementation of a Lock-In Amplifier.
- Provides simplicity in design with near "Black Box" performance.
- Additional benefits include programmable IIR Filter and in-phase and quadrature detection.
- A 16 Bit ADC (AD7171) was also paired with the ADA2200 to provide more granular digital measurements.

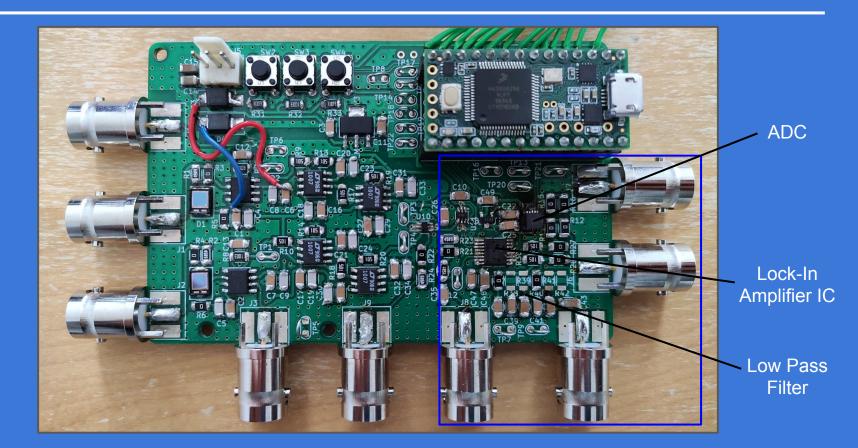


Inverting Voltage Amplifiers



Analogue Switches for Modulation and Multiplexing

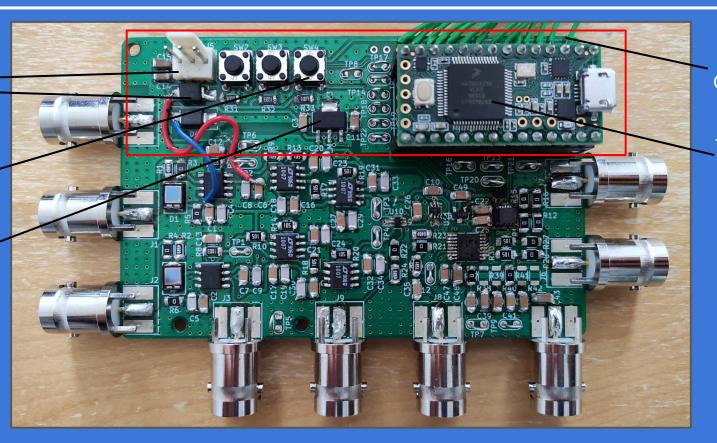




Power Connection and Voltage Protection

> Control Buttons

3.3V Regulator



LCD Connection

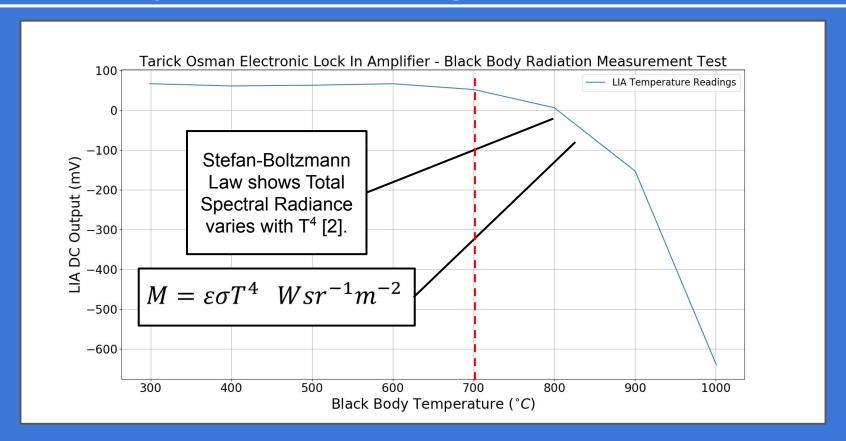
Teensy 3.2 MCU

Design Benefits

- Modern Lock-In Amplifier IC allows for In-Phase and Quadrature measurements [10]. The phase difference of the Input and Reference signals is not important.
- Capable of 1 Billion Gain before the LIA.
- BNCs allow for flexible usage of the design.
- Teensy 3.2 supports Arduino programming. Allows for onboard DSP, a User Interface and Serial Communications over USB.
- Small Form Factor, roughly the size of a Raspberry Pi.
- Low Cost design at £95 (More information in BOM).

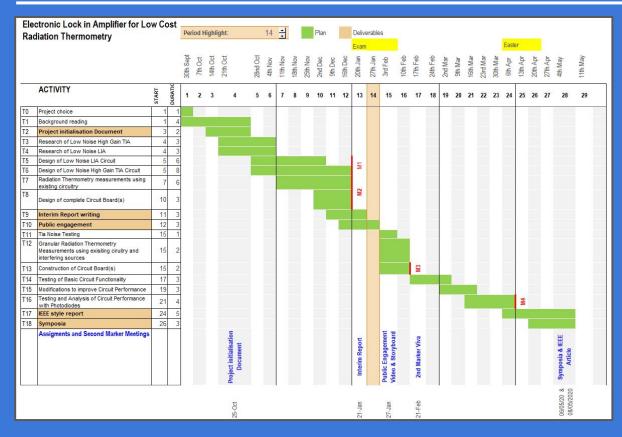
Benchmark Testing

Black Body Radiation Testing



Milestones and Future Work

Milestones and Gantt Chart



M1 → Completed Low Noise High Gain TIA/LIA Circuit Design.

M2 ⇒ Completely Radiation Thermometry Measurements and TIA/LIA PCB Design.

M3 ⇒ TIA/LIA PCB Constructed.

M4 ⇒ TIA/LIA PCB performance with Photodiodes tested.

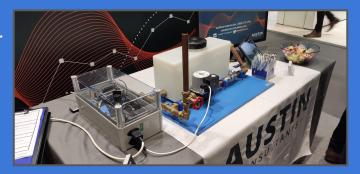
Future Work

- 1. Additional characterisation of TIA Noise Performance.
- 2. Additional Black Body Radiation Testing to produce a more granular curve for TO LIA and ascertain the effect of interfering external sources of Infrared.
- 3. Continued testing of Lock-In Amplifier PCB to find problems with the first practical version. Revised version to be tested following manufacture.
- 4. Development of a custom serial interface and GUI to allow for PC control of the LIA.
- Perform further Black Body Radiation Testing with the new design to quantify the improvement in performance Tarick Osman's design.

Wider Developments in Electronics

The Internet of Things

- Connection of a range of devices to the internet and cloud for granular data logging and communications.
- Very large applications in Industrial Sectors, particularly in Manufacturing where sensors track production activities and failures.
- Companies such as Siemens and Festo developing integrated IOT and Cloud Computing platforms that integrate closely with their manufacturing equipment, such as MindSphere.
- IOT works hand in hand with new technologies such as Machine Learning to allow for more accurate and reliable predictive maintenance and production planning.





ML, DSP and FPGAs

- Many processor developers and manufacturers
 (ARM, Intel, AMD) are providing dedicated hardware
 for Machine Learning and DSP applications as part
 of their designs.
- This attempts to improve computing performance on small devices, allowing embedded systems to perform more complex signal processing and analysis.
- FPGA manufacturers are now packaging processors into designs. FPGAs include optimised DSP and ML "slices" to provide improved performance in custom hardware designs.



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To Conclude

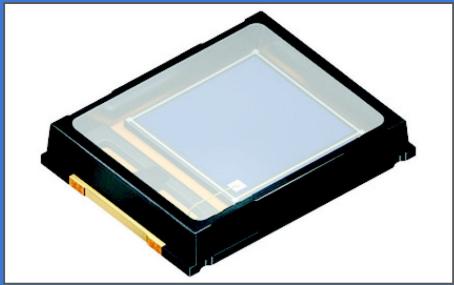
- Radiation Thermometry can solve many of the problems produced by Contact Thermometers in High Temperature environments.
- Lock-In Amplifiers are a good method of detecting signals from Photodiodes down to pA range.
- A fully electronic Lock-In Amplifier circuit has been developed and manufactured at the proof of concept stage. Further revision is required.
- Testing of the new design with the Radiation Thermometry setup will be completed to ascertain the improvement in performance over the previous design produced by Tarick Osman.

References

- [1] D. P. DeWitt, Applications of Radiation Thermometry. ASTM, 1985.
- [2] P. Saunders, Radiation Thermometry Fundamentals and Applications in the Petrochemical Industry. Bellingham, Washington 98227-0010 USA: SPIE, 2007.
- [3] P. Horowitz, The Art of Electronics, Third edition. New York, NY: Cambridge University Press, 2015.
- [4] 'Stanford Research Systems SR810 and SR830 Lock in Amplifiers', Stanford Research Systems, Jan-2020. [Online]. Available: https://www.thinksrs.com/products/sr810830.html.
- [5] T. Osman, 'Electronic Lock-In Amplifier for Measuring Low Optical Power', Univ. Sheff., 2019.
- [6] 'About Lock in Amplifiers'. Stanford Research Systems, Jan-2020.
- [7] Analog Devices, 'LT SPICE', LT SPICE Design Center, Jan-2020. [Online]. Available: https://www.analog.com/en/design-center/design-tools-and-calculators/ltspice-simulator.html
- [8] Analog Devices, 'AD795 Operational Amplifier Datasheet'. Analog Devices, 2019.
- [9] Analog Devices, 'AD8065 Operational Amplifier Datasheet'. Analog Devices, 2019.
- [10] Analog Devices, 'ADA2200 Synchronous Demodulator Datasheet'. Analog Devices.

Additional Slides

Photodiode Selection



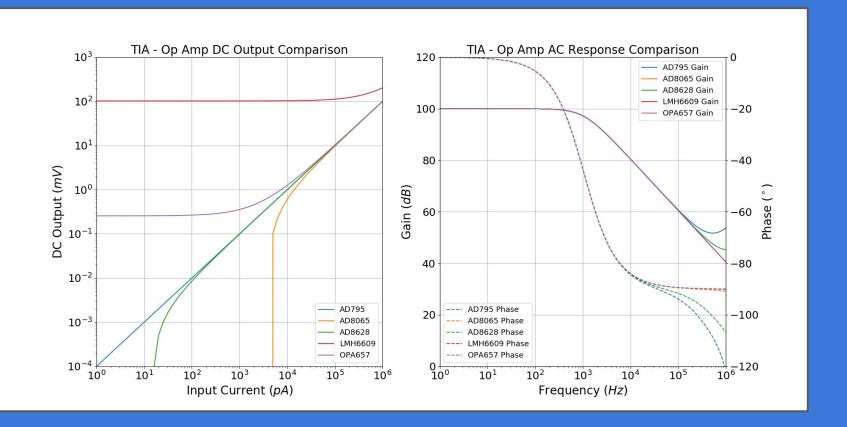
www.osram.com

- 1nA Dark Current
- 7.02mm² Radiant Sensitive Area
- 300 1100nm Operating Wavelength Range
- 0.7 A/W Peak Spectral Sensitivity
- 60pF Junction Capacitance

- Lower junction capacitance ensures TIA Gain is not adversely affected.
- Wide wavelength response ensures that the a wider section of the Black Body radiation spectrum is absorbed.
- Larger sensitive area provides a larger signal for measurement.

Provides a good tradeoff between Junction Capacitance and Radiant Sensitive Area.

TIA Operational Amplifier Selection



TIA Operational Amplifier Selection

